

# MOSFET

## OptiMOS™ 5 Power-Transistor, 25 V

### Features

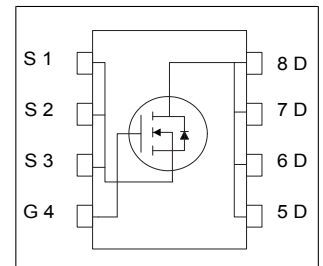
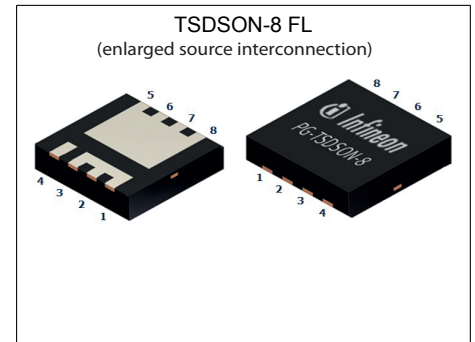
- Optimized for e-fuse and ORing application
- Very low on-resistance  $R_{DS(on)}$
- 100% avalanche tested
- Superior thermal resistance
- N-channel
- Pb-free lead plating; RoHS compliant
- Halogen-free according to IEC61249-2-21

### Product validation

Fully qualified according to JEDEC for Industrial Applications

**Table 1 Key Performance Parameters**

| Parameter        | Value | Unit       |
|------------------|-------|------------|
| $V_{DS}$         | 25    | V          |
| $R_{DS(on),max}$ | 0.9   | m $\Omega$ |
| $I_D$            | 40    | A          |
| $Q_{oss}$        | 26    | nC         |
| $Q_G(0V..10V)$   | 92    | nC         |
| $Q_G(0V..4.5V)$  | 52    | nC         |



| Type / Ordering Code | Package        | Marking | Related Links |
|----------------------|----------------|---------|---------------|
| BSZ009NE2LS5         | PG-TSDSON-8 FL | 09NE2L5 | -             |

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## 1 Maximum ratings

at  $T_A=25\text{ °C}$ , unless otherwise specified

**Table 2 Maximum ratings**

| Parameter                                    | Symbol         | Values |      |                            | Unit | Note / Test Condition                                                                                                                                                                                                                                                 |
|----------------------------------------------|----------------|--------|------|----------------------------|------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
|                                              |                | Min.   | Typ. | Max.                       |      |                                                                                                                                                                                                                                                                       |
| Continuous drain current                     | $I_D$          | -      | -    | 40<br>40<br>40<br>40<br>39 | A    | $V_{GS}=10\text{ V}$ , $T_C=25\text{ °C}$<br>$V_{GS}=10\text{ V}$ , $T_C=100\text{ °C}$<br>$V_{GS}=4.5\text{ V}$ , $T_C=25\text{ °C}$<br>$V_{GS}=4.5\text{ V}$ , $T_C=100\text{ °C}$<br>$V_{GS}=10\text{ V}$ , $T_A=25\text{ °C}$ ,<br>$R_{THJA}=60\text{ °C/W}^{1)}$ |
| Pulsed drain current <sup>2)</sup>           | $I_{D,pulse}$  | -      | -    | 160                        | A    | $T_C=25\text{ °C}$                                                                                                                                                                                                                                                    |
| Avalanche energy, single pulse <sup>3)</sup> | $E_{AS}$       | -      | -    | 160                        | mJ   | $I_D=20\text{ A}$ , $R_{GS}=25\text{ }\Omega$                                                                                                                                                                                                                         |
| Gate source voltage                          | $V_{GS}$       | -16    | -    | 16                         | V    | -                                                                                                                                                                                                                                                                     |
| Power dissipation                            | $P_{tot}$      | -      | -    | 69<br>2.1                  | W    | $T_C=25\text{ °C}$<br>$T_A=25\text{ °C}$ , $R_{THJA}=60\text{ °C/W}^{1)}$                                                                                                                                                                                             |
| Operating and storage temperature            | $T_j, T_{stg}$ | -55    | -    | 150                        | °C   | IEC climatic category; DIN IEC 68-1:<br>55/150/56                                                                                                                                                                                                                     |

## 2 Thermal characteristics

**Table 3 Thermal characteristics**

| Parameter                                     | Symbol     | Values |      |      | Unit | Note / Test Condition |
|-----------------------------------------------|------------|--------|------|------|------|-----------------------|
|                                               |            | Min.   | Typ. | Max. |      |                       |
| Thermal resistance, junction - case, bottom   | $R_{thJC}$ | -      | -    | 1.8  | °C/W | -                     |
| Thermal resistance, junction - case, top      | $R_{thJC}$ | -      | -    | 20   | °C/W | -                     |
| Device on PCB, 6 cm <sup>2</sup> cooling area | $R_{thJA}$ | -      | -    | 60   | °C/W | -                     |

<sup>1)</sup> Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm<sup>2</sup> (one layer, 70 µm thick) copper area for drain connection. PCB is vertical in still air.

<sup>2)</sup> See Diagram 3 for more detailed information

<sup>3)</sup> See Diagram 13 for more detailed information

### 3 Electrical characteristics

at  $T_j=25\text{ °C}$ , unless otherwise specified

**Table 4 Static characteristics**

| Parameter                        | Symbol        | Values |              |            | Unit             | Note / Test Condition                                                                                                               |
|----------------------------------|---------------|--------|--------------|------------|------------------|-------------------------------------------------------------------------------------------------------------------------------------|
|                                  |               | Min.   | Typ.         | Max.       |                  |                                                                                                                                     |
| Drain-source breakdown voltage   | $V_{(BR)DSS}$ | 25     | -            | -          | V                | $V_{GS}=0\text{ V}$ , $I_D=1\text{ mA}$                                                                                             |
| Gate threshold voltage           | $V_{GS(th)}$  | 1.2    | -            | 2          | V                | $V_{DS}=V_{GS}$ , $I_D=250\text{ }\mu\text{A}$                                                                                      |
| Zero gate voltage drain current  | $I_{DSS}$     | -      | 0.1<br>10    | 1<br>100   | $\mu\text{A}$    | $V_{DS}=20\text{ V}$ , $V_{GS}=0\text{ V}$ , $T_j=25\text{ °C}$<br>$V_{DS}=20\text{ V}$ , $V_{GS}=0\text{ V}$ , $T_j=125\text{ °C}$ |
| Gate-source leakage current      | $I_{GSS}$     | -      | 10           | 100        | nA               | $V_{GS}=16\text{ V}$ , $V_{DS}=0\text{ V}$                                                                                          |
| Drain-source on-state resistance | $R_{DS(on)}$  | -      | 0.70<br>0.96 | 0.9<br>1.2 | $\text{m}\Omega$ | $V_{GS}=10\text{ V}$ , $I_D=20\text{ A}$<br>$V_{GS}=4.5\text{ V}$ , $I_D=20\text{ A}$                                               |
| Gate resistance                  | $R_G$         | -      | 0.7          | 1.2        | $\Omega$         | -                                                                                                                                   |
| Transconductance                 | $g_{fs}$      | 70     | 140          | -          | S                | $ V_{DS} \geq 2 I_D /R_{DS(on)max}$ , $I_D=20\text{ A}$                                                                             |

**Table 5 Dynamic characteristics**

| Parameter                        | Symbol       | Values |      |      | Unit | Note / Test Condition                                                                              |
|----------------------------------|--------------|--------|------|------|------|----------------------------------------------------------------------------------------------------|
|                                  |              | Min.   | Typ. | Max. |      |                                                                                                    |
| Input capacitance                | $C_{iss}$    | -      | 4200 | 5500 | pF   | $V_{GS}=0\text{ V}$ , $V_{DS}=12\text{ V}$ , $f=1\text{ MHz}$                                      |
| Output capacitance <sup>1)</sup> | $C_{oss}$    | -      | 1200 | 1600 | pF   | $V_{GS}=0\text{ V}$ , $V_{DS}=12\text{ V}$ , $f=1\text{ MHz}$                                      |
| Reverse transfer capacitance     | $C_{rss}$    | -      | 1100 | -    | pF   | $V_{GS}=0\text{ V}$ , $V_{DS}=12\text{ V}$ , $f=1\text{ MHz}$                                      |
| Turn-on delay time               | $t_{d(on)}$  | -      | 7    | -    | ns   | $V_{DD}=12\text{ V}$ , $V_{GS}=10\text{ V}$ , $I_D=20\text{ A}$ ,<br>$R_{G,ext}=1.6\text{ }\Omega$ |
| Rise time                        | $t_r$        | -      | 9    | -    | ns   | $V_{DD}=12\text{ V}$ , $V_{GS}=10\text{ V}$ , $I_D=20\text{ A}$ ,<br>$R_{G,ext}=1.6\text{ }\Omega$ |
| Turn-off delay time              | $t_{d(off)}$ | -      | 31   | -    | ns   | $V_{DD}=12\text{ V}$ , $V_{GS}=10\text{ V}$ , $I_D=20\text{ A}$ ,<br>$R_{G,ext}=1.6\text{ }\Omega$ |
| Fall time                        | $t_f$        | -      | 17   | -    | ns   | $V_{DD}=12\text{ V}$ , $V_{GS}=10\text{ V}$ , $I_D=20\text{ A}$ ,<br>$R_{G,ext}=1.6\text{ }\Omega$ |

**Table 6 Gate charge characteristics<sup>2)</sup>**

| Parameter                       | Symbol        | Values |      |      | Unit | Note / Test Condition                                                        |
|---------------------------------|---------------|--------|------|------|------|------------------------------------------------------------------------------|
|                                 |               | Min.   | Typ. | Max. |      |                                                                              |
| Gate to source charge           | $Q_{gs}$      | -      | 10.6 | -    | nC   | $V_{DD}=12\text{ V}$ , $I_D=20\text{ A}$ , $V_{GS}=0\text{ to }4.5\text{ V}$ |
| Gate charge at threshold        | $Q_{g(th)}$   | -      | 6.1  | -    | nC   | $V_{DD}=12\text{ V}$ , $I_D=20\text{ A}$ , $V_{GS}=0\text{ to }4.5\text{ V}$ |
| Gate to drain charge            | $Q_{gd}$      | -      | 28   | -    | nC   | $V_{DD}=12\text{ V}$ , $I_D=20\text{ A}$ , $V_{GS}=0\text{ to }4.5\text{ V}$ |
| Switching charge                | $Q_{sw}$      | -      | 32   | -    | nC   | $V_{DD}=12\text{ V}$ , $I_D=20\text{ A}$ , $V_{GS}=0\text{ to }4.5\text{ V}$ |
| Gate charge total <sup>1)</sup> | $Q_g$         | -      | 52   | 70   | nC   | $V_{DD}=12\text{ V}$ , $I_D=20\text{ A}$ , $V_{GS}=0\text{ to }4.5\text{ V}$ |
| Gate plateau voltage            | $V_{plateau}$ | -      | 2.5  | -    | V    | $V_{DD}=12\text{ V}$ , $I_D=20\text{ A}$ , $V_{GS}=0\text{ to }4.5\text{ V}$ |
| Gate charge total <sup>1)</sup> | $Q_g$         | -      | 92   | 124  | nC   | $V_{DD}=12\text{ V}$ , $I_D=20\text{ A}$ , $V_{GS}=0\text{ to }10\text{ V}$  |
| Gate charge total, sync. FET    | $Q_{g(sync)}$ | -      | 33   | -    | nC   | $V_{DS}=0.1\text{ V}$ , $V_{GS}=0\text{ to }4.5\text{ V}$                    |
| Output charge <sup>1)</sup>     | $Q_{oss}$     | -      | 26   | 35   | nC   | $V_{DD}=12\text{ V}$ , $V_{GS}=0\text{ V}$                                   |

<sup>1)</sup> Defined by design. Not subject to production test

<sup>2)</sup> See "Gate charge waveforms" for parameter definition

**Table 7 Reverse diode**

| Parameter                        | Symbol        | Values |      |      | Unit | Note / Test Condition                                                      |
|----------------------------------|---------------|--------|------|------|------|----------------------------------------------------------------------------|
|                                  |               | Min.   | Typ. | Max. |      |                                                                            |
| Diode continuous forward current | $I_S$         | -      | -    | 40   | A    | $T_C=25\text{ °C}$                                                         |
| Diode pulse current              | $I_{S,pulse}$ | -      | -    | 160  | A    | $T_C=25\text{ °C}$                                                         |
| Diode forward voltage            | $V_{SD}$      | -      | 0.76 | 1    | V    | $V_{GS}=0\text{ V}$ , $I_F=20\text{ A}$ , $T_j=25\text{ °C}$               |
| Reverse recovery charge          | $Q_{rr}$      | -      | 20   | -    | nC   | $V_R=12\text{ V}$ , $I_F=20\text{ A}$ , $di_F/dt=400\text{ A/}\mu\text{s}$ |

## 4 Electrical characteristics diagrams

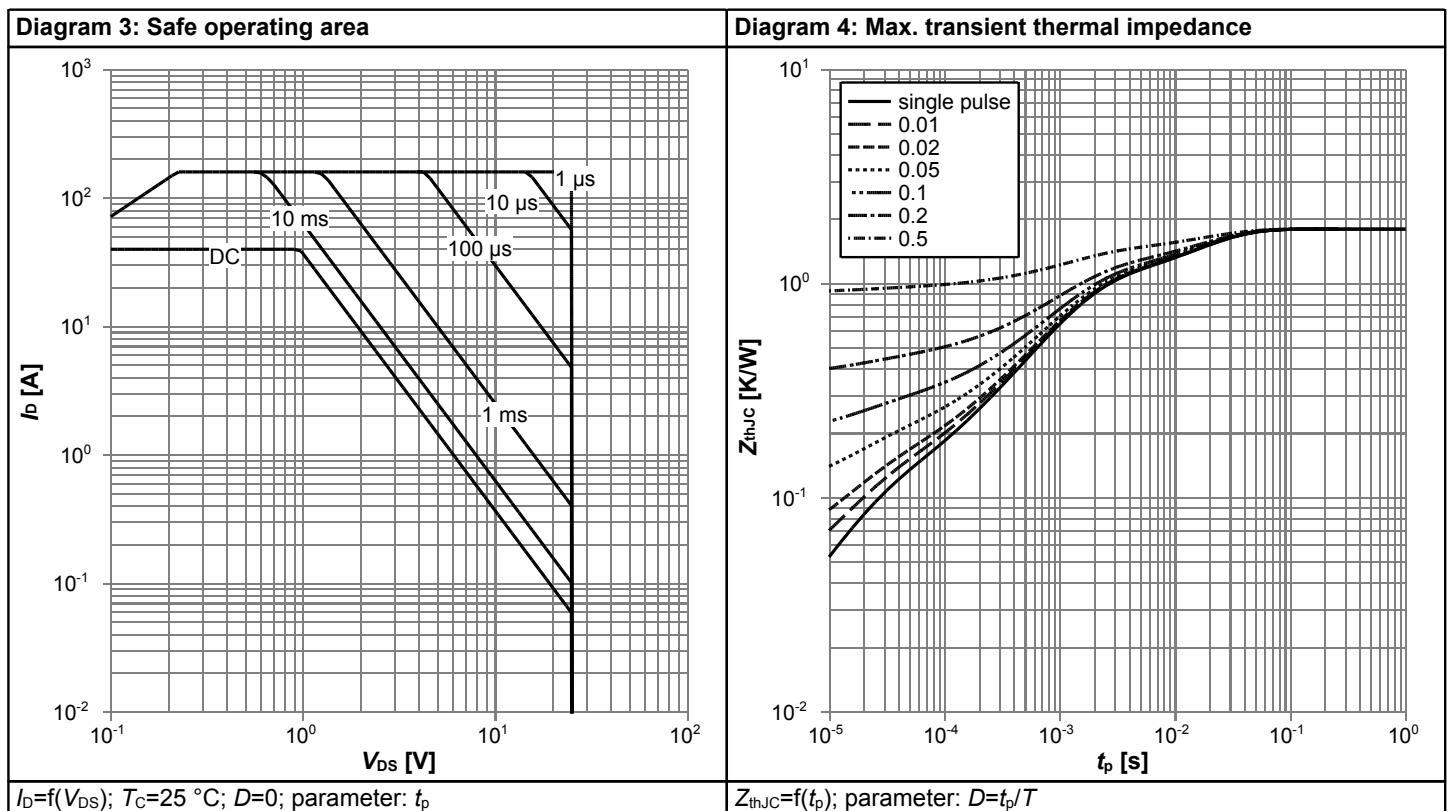
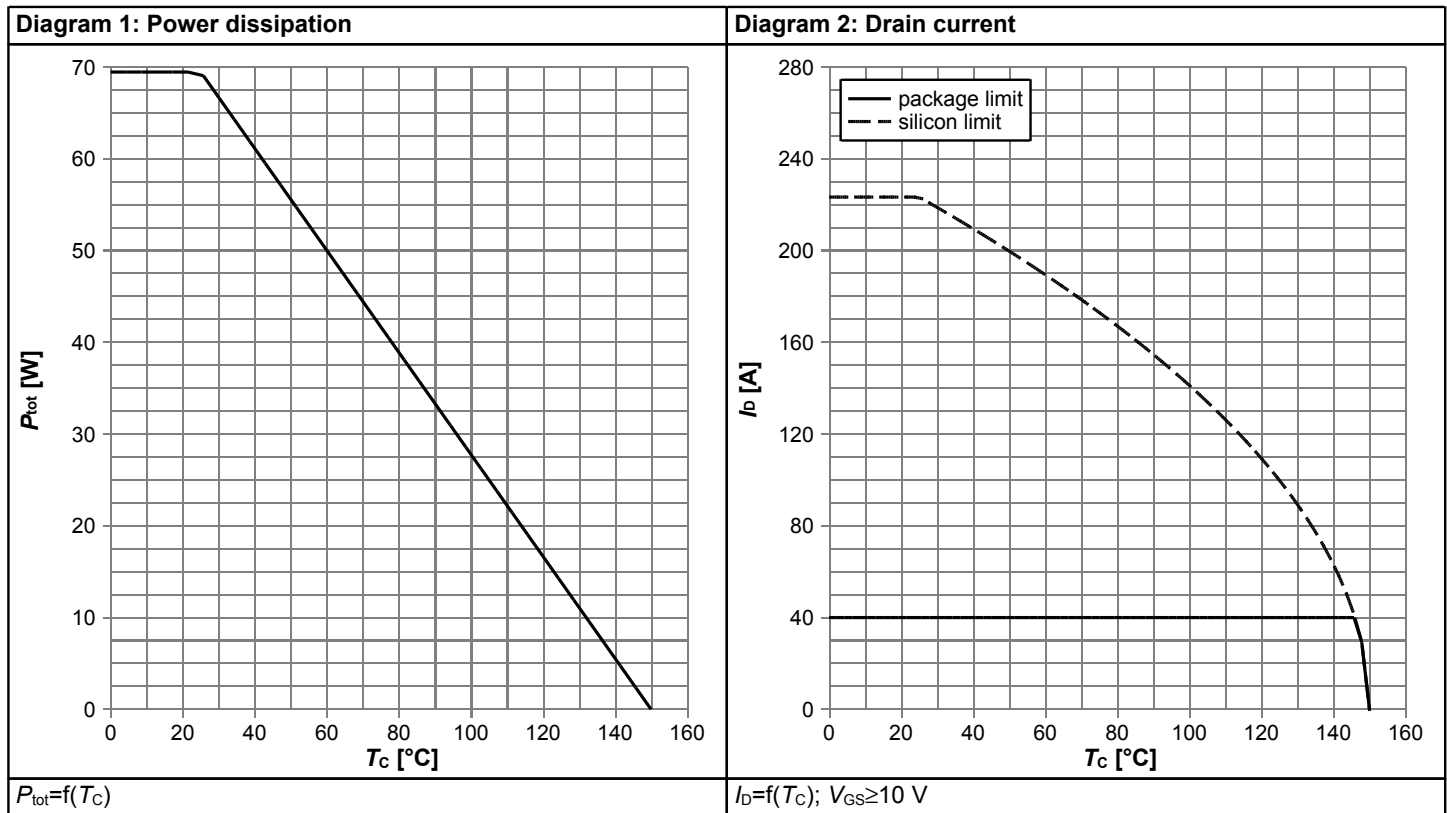
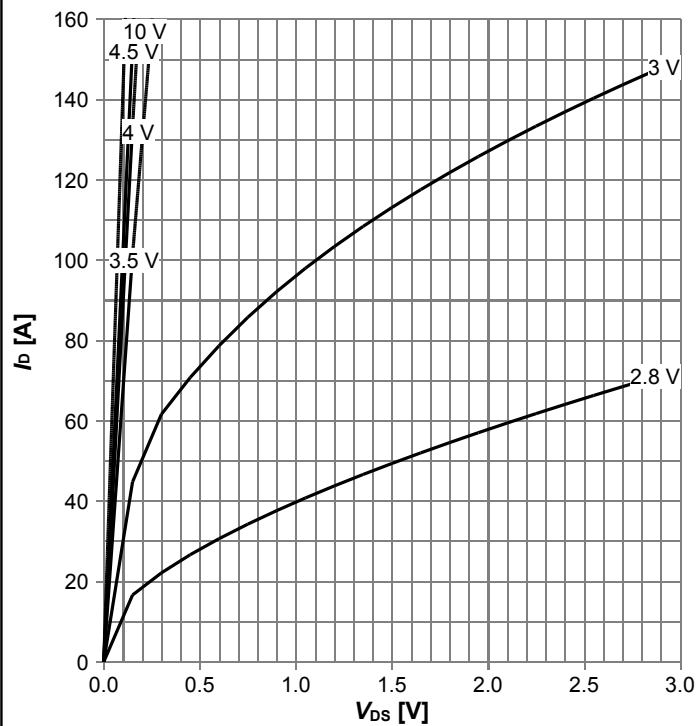
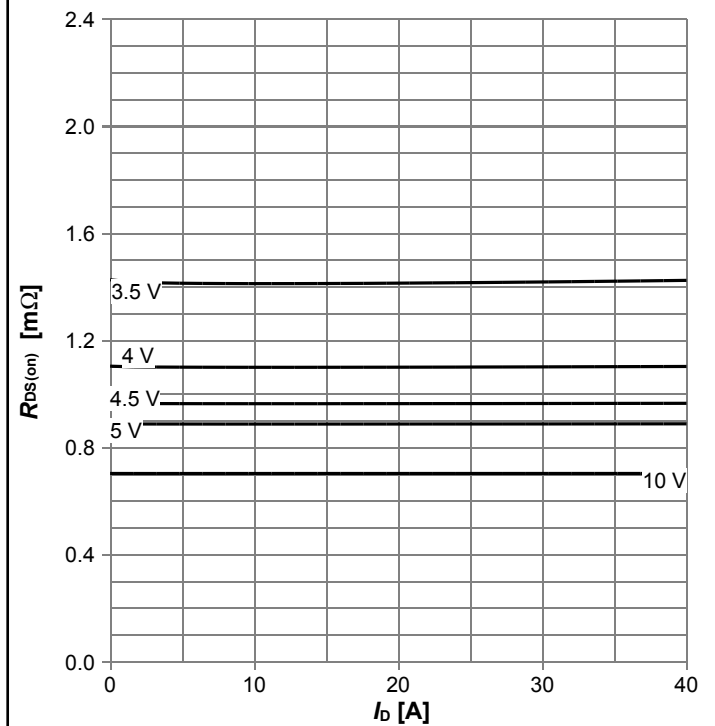


Diagram 5: Typ. output characteristics



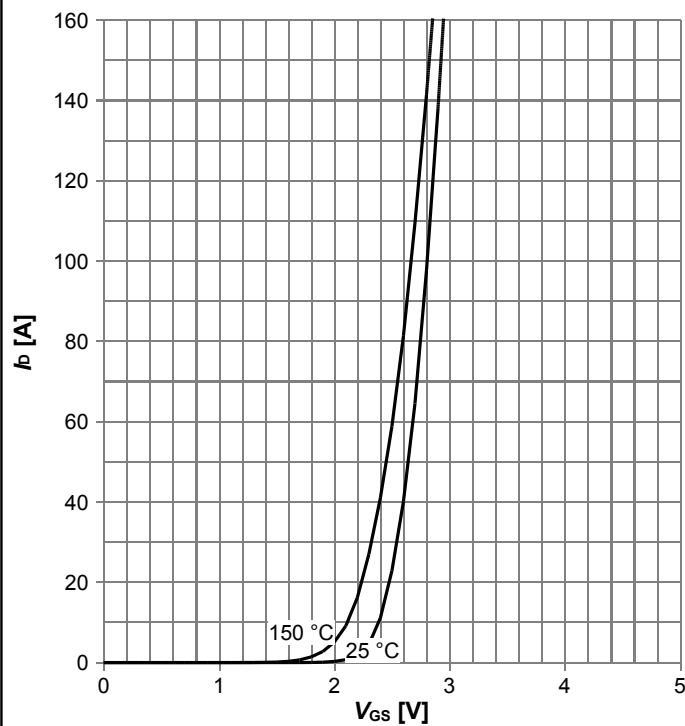
$I_D = f(V_{DS})$ ,  $T_j = 25^\circ\text{C}$ ; parameter:  $V_{GS}$

Diagram 6: Typ. drain-source on resistance



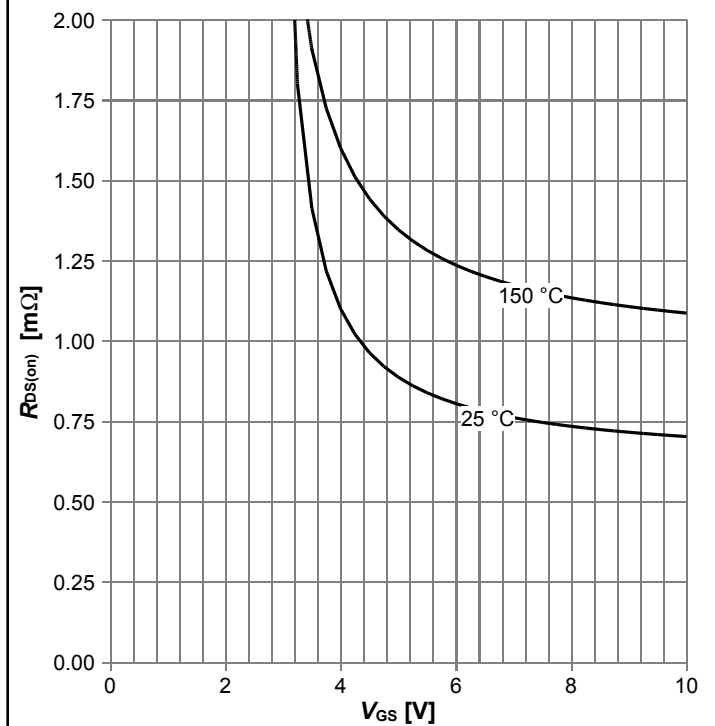
$R_{DS(on)} = f(I_D)$ ,  $T_j = 25^\circ\text{C}$ ; parameter:  $V_{GS}$

Diagram 7: Typ. transfer characteristics



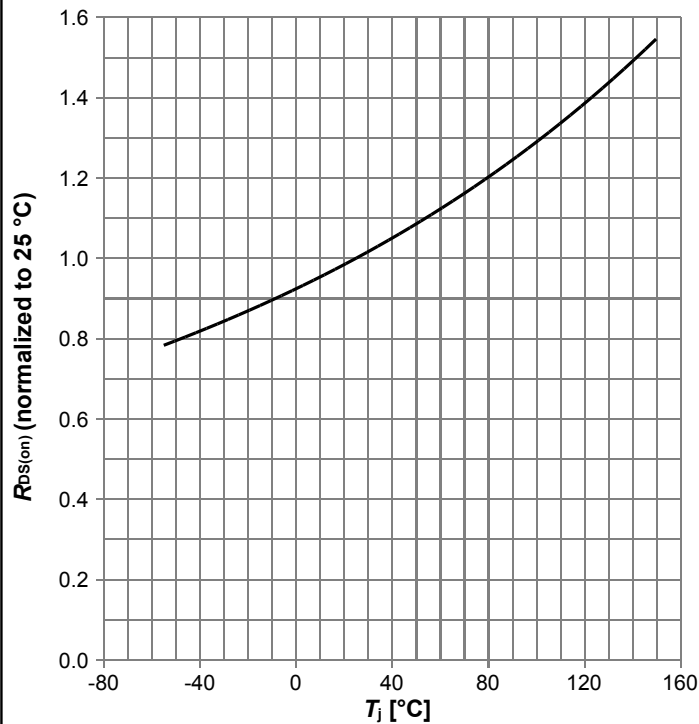
$I_D = f(V_{GS})$ ,  $|V_{DS}| > 2|I_D|R_{DS(on)max}$ ; parameter:  $T_j$

Diagram 8: Typ. drain-source on resistance



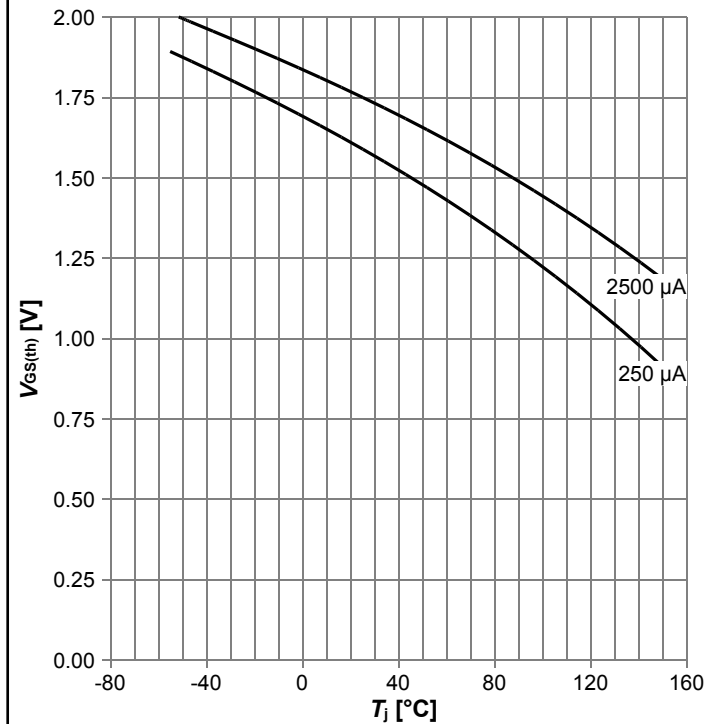
$R_{DS(on)} = f(V_{GS})$ ,  $I_D = 20\text{ A}$ ; parameter:  $T_j$

Diagram 9: Normalized drain-source on resistance



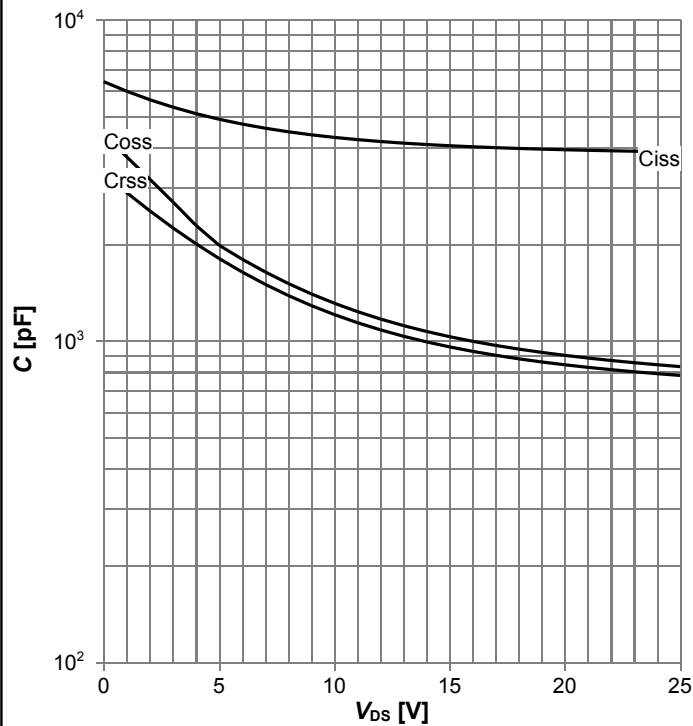
$R_{DS(on)} = f(T_j)$ ,  $I_D = 20 \text{ A}$ ,  $V_{GS} = 10 \text{ V}$

Diagram 10: Typ. gate threshold voltage



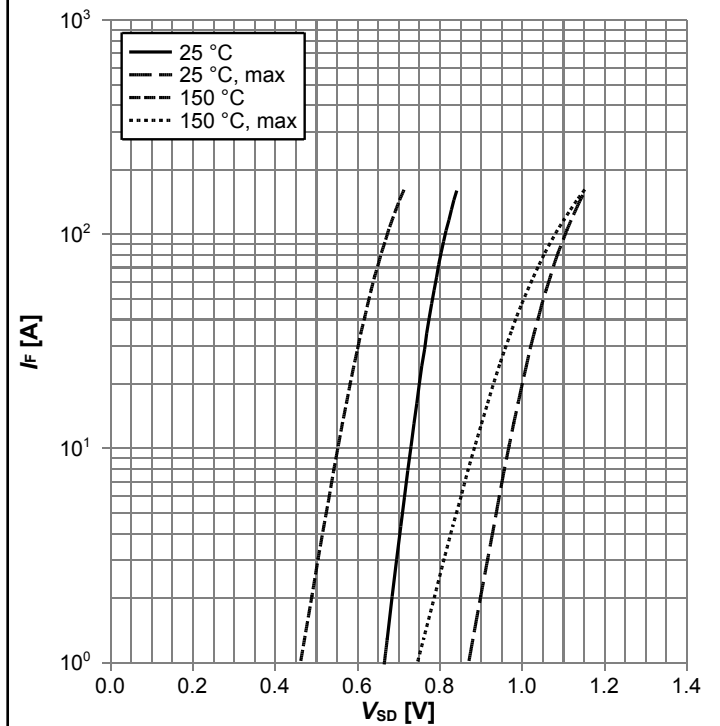
$V_{GS(th)} = f(T_j)$ ,  $V_{GS} = V_{DS}$ ; parameter:  $I_D$

Diagram 11: Typ. capacitances



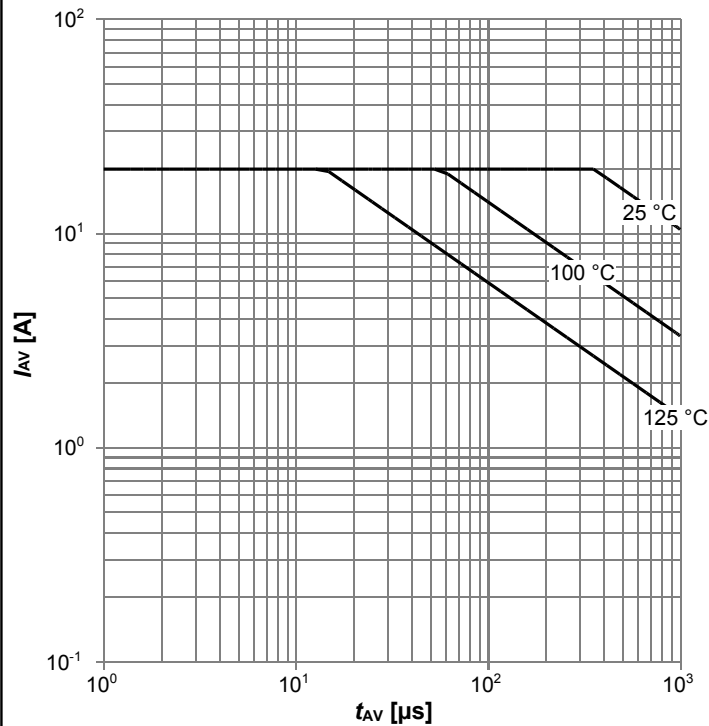
$C = f(V_{DS})$ ;  $V_{GS} = 0 \text{ V}$ ;  $f = 1 \text{ MHz}$

Diagram 12: Forward characteristics of reverse diode



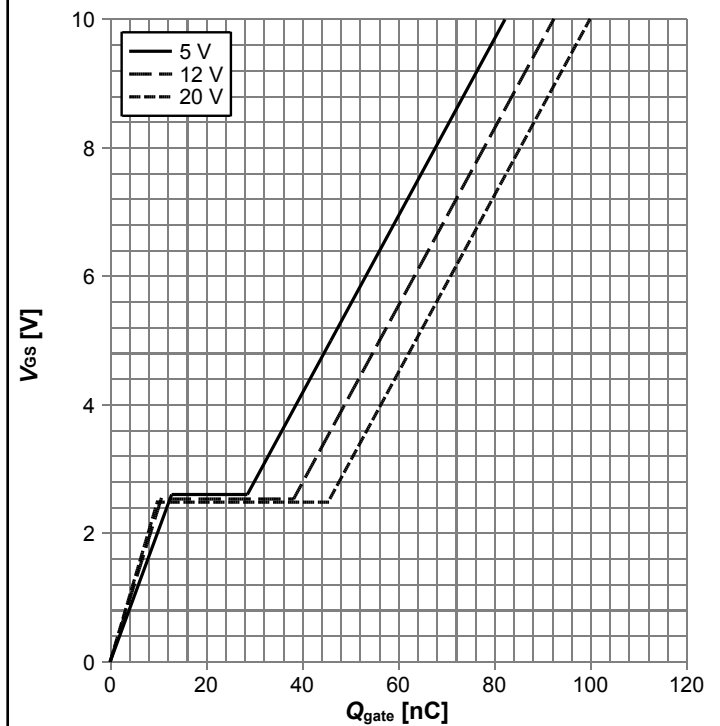
$I_F = f(V_{SD})$ ; parameter:  $T_j$

Diagram 13: Avalanche characteristics



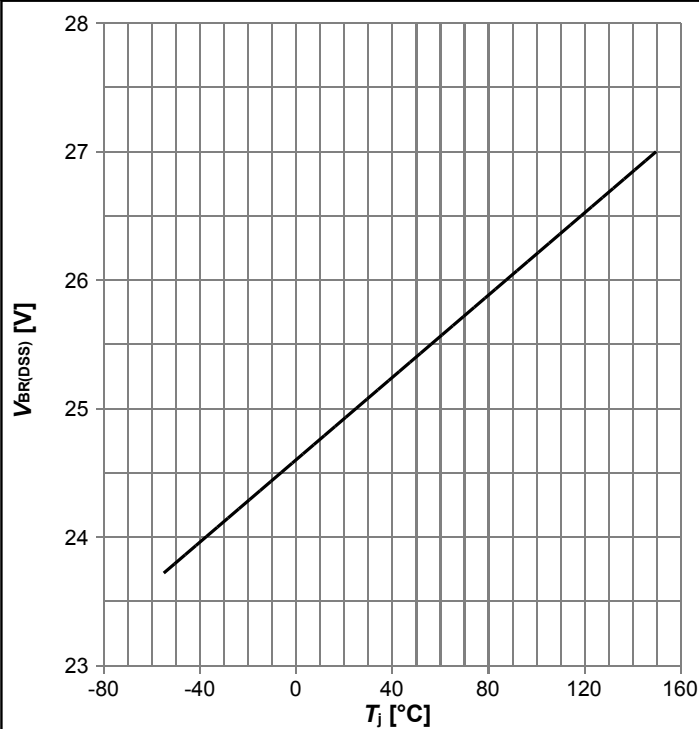
$I_{AS}=f(t_{AV})$ ;  $R_{GS}=25\ \Omega$ ; parameter:  $T_{j,start}$

Diagram 14: Typ. gate charge



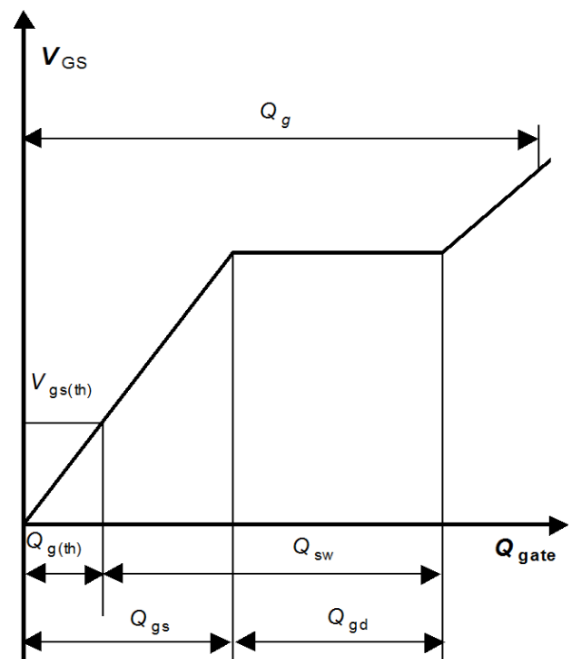
$V_{GS}=f(Q_{gate})$ ,  $I_D=20\text{ A}$  pulsed,  $T_j=25\text{ °C}$ ; parameter:  $V_{DD}$

Diagram 15: Drain-source breakdown voltage



$V_{BR(DSS)}=f(T_j)$ ;  $I_D=1\text{ mA}$

Diagram Gate charge waveforms



## 5 Package Outlines

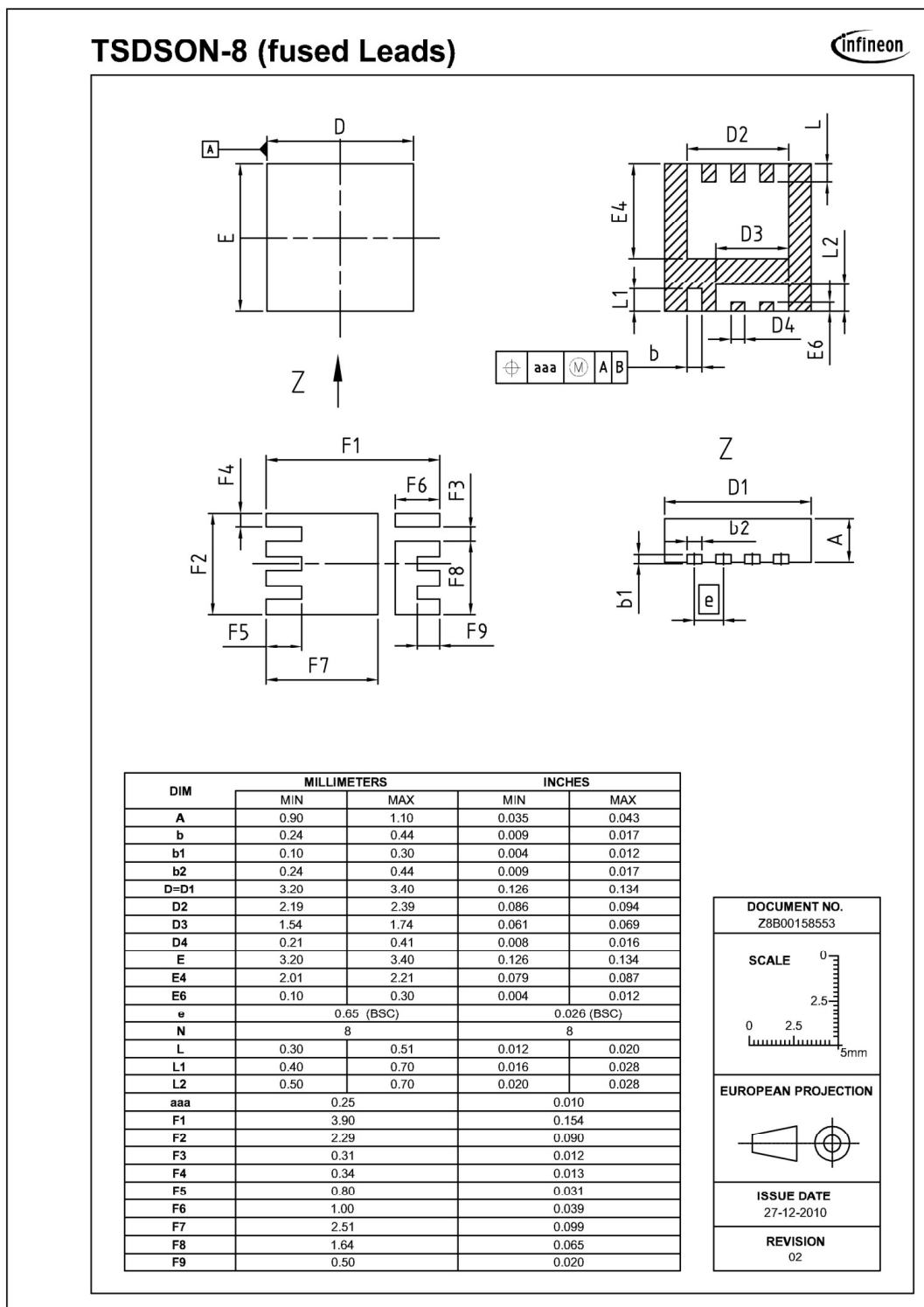


Figure 1 Outline PG-TSDSON-8 FL, dimensions in mm/inches

## Revision History

BSZ009NE2LS5

**Revision: 2019-02-04, Rev. 2.0**

Previous Revision

| Revision | Date       | Subjects (major changes since last revision) |
|----------|------------|----------------------------------------------|
| 2.0      | 2019-02-04 | Release of final version                     |

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